

Data sheet acquired from Harris Semiconductor SCHS208D

February 1998 - Revised August 2003

High-Speed CMOS Logic Quad Bilateral Switch

Fea	tui	es
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•	Wide Analog-Input-Voltage Range 0V - 10
•	Low "ON" Resistance
	- V _{CC} = 4.5V
	- V _{CC} = 9V

- Fast Switching and Propagation Delay Times
- Low "OFF" Leakage Current
- Wide Operating Temperature Range . . . -55°C to 125°C
- HC Types
 - 2V to 10V Operation
 - High Noise Immunity: N_{IL} = 30%, N_{IH} = 30% of V_{CC} at V_{CC} = 5V and 10V
- HCT Types
 - Direct LSTTL Input Logic Compatibility,
 V_{IL}= 0.8V (Max), V_{IH} = 2V (Min)
 - CMOS Input Compatibility, I_I \leq 1 μ A at V_{OL}, V_{OH}

Description

The 'HC4066 and CD74HCT4066 contain four independent digitally controlled analog switches that use silicon-gate CMOS technology to achieve operating speeds similar to LSTTL with the low power consumption of standard CMOS integrated circuits.

These switches feature the characteristic linear "ON" resistance of the metal-gate CD4066B. Each switch is turned on by a high-level voltage on its control input.

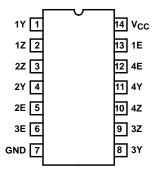
Ordering Information

PART NUMBER	TEMP. RANGE (°C)	PACKAGE
CD54HC4066F3A	-55 to 125	14 Ld CERDIP
CD74HC4066E	-55 to 125	14 Ld PDIP
CD74HC4066M	-55 to 125	14 Ld SOIC
CD74HC4066MT	-55 to 125	14 Ld SOIC
CD74HC4066M96	-55 to 125	14 Ld SOIC
CD74HC4066PW	-55 to 125	14 Ld TSSOP
CD74HC4066PWR	-55 to 125	14 Ld TSSOP
CD74HC4066PWT	-55 to 125	14 Ld TSSOP
CD74HCT4066E	-55 to 125	14 Ld PDIP
CD74HCT4066M	-55 to 125	14 Ld SOIC
CD74HCT4066MT	-55 to 125	14 Ld SOIC
CD74HCT4066M96	-55 to 125	14 Ld SOIC

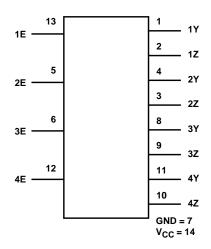
NOTE: When ordering, use the entire part number. The suffixes 96 and R denote tape and reel. The suffix T denotes a small-quantity reel of 250.

Pinout

CD54HC4066 (CERDIP)
CD74HC4066 (PDIP, SOIC, TSSOP)
CD74HCT4066 (PDIP, SOIC)
TOP VIEW



Functional Diagram

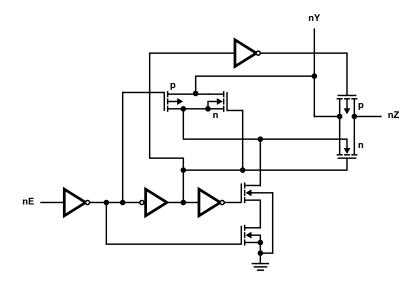


TRUTH TABLE

INPUT nE	SWITCH
L	Off
Н	On

H= High Level L= Low Level

Logic Diagram



Absolute Maximum Ratings

_
DC Supply Voltage, V _{CC}
HCT Types0.5V to 7V
HC Types0.5V to 10.5V
DC Input Diode Current, I _{IK}
For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$
DC Switch Current, I _O (Note 1)
For $-0.5V < V_O < V_{CC} + 0.5V$
DC Output Diode Current, IOK
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ ±20mA
DC Output Source or Sink Current per Output Pin, IO
For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$
DC V _{CC} or Ground Current, I _{CC}

Thermal Information

Thermal Resistance (Typical, Note 2)

Thermal Resistance (Typical, 146te 2)	UJA
E (PDIP) Package	80°C/W
M (SOIC) Package	86°C/W
PW (TSSOP) Package	113 ⁰ C/W
Maximum Junction Temperature (Hermetic Package or Die)) 175 ⁰ C
Maximum Junction Temperature (Plastic Package)	150 ⁰ C
Maximum Storage Temperature Range65 ^o	C to 150°C
Maximum Lead Temperature (Soldering 10s)	300°C
(SOIC - Lead Tips Only)	

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Operating Conditions

Temperature Range, T_A 55°C to 125°C Supply Voltage Range, V_{CC}
HC Types2V to 10V
HCT Types
DC Input or Output Voltage, V _I , V _O
Input Rise and Fall Time
2V
4.5V 500ns (Max)
6V

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

- In certain applications, the external load-resistor current may include both V_{CC} and signal-line components. To avoid drawing V_{CC} current when switch current flows into the transmission gate inputs, (terminals 1, 4, 8 and 11) the voltage drop across the bidirectional switch must not exceed 0.6V (calculated from R_{ON} values shown in the DC Electrical Specifications Table). No V_{CC} current will flow through R_Lif the switch current flows into terminals 2, 3, 9 and 10.
- 2. The package thermal impedance is calculated in accordance with JESD 51-7.

DC Electrical Specifications

			ST ITIONS			25°C		-40°C TO 85°C		-55°C TO 125°C		
PARAMETER	SYMBOL	V _I (V)	V _{IS} (V)	V _{CC} (V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
HC TYPES	HC TYPES											
High Level Input	V _{IH}	-	-	2	1.5	-	-	1.5	-	1.5	-	V
Voltage				4.5	3.15	-	-	3.15	-	3.15	-	V
				9	6.3	-	-	6.3	-	6.3	-	V
Low Level Input	V _{IL}	-	-	2	-	-	0.5	-	0.5	-	0.5	V
Voltage				4.5	-	-	1.35	-	1.35	-	1.35	V
				9	-	-	2.7	-	2.7	-	2.7	V
Input Leakage Current (Any Control)	I _{IL}	V _{CC} or GND	-	10	-	-	±0.1	-	±1	-	±1	μА
Off-Switch Leakage Current	IZ	V _{IL}	V _{CC} or GND	10	-	-	±0.1	-	±1	-	±1	μΑ

DC Electrical Specifications (Continued)

			ST ITIONS 25°C			-40°C T	O 85°C	-55°C TO 125°C				
PARAMETER	SYMBOL	V _I (V)	V _{IS} (V)	V _{CC} (V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
"ON" Resistance	R _{ON}	V _{CC}	V _{CC} or	4.5	-	25	80	-	106	-	128	Ω
I _O = 1mA (Figure 1)			GND	6	-	20	75	-	94	-	113	Ω
				9	-	15	60	-	78	-	95	Ω
			V _{CC} to	4.5	ı	35	95	-	118	-	142	Ω
			GND	6	1	24	84	-	105	-	126	Ω
				9	-	16	70	-	88	-	105	Ω
"ON" Resistance	ΔR _{ON}	V _{CC}	-	4.5	ı	1	-	-	-	-	-	Ω
Between Any Two Switches				6	1	0.75	-	-	-	-	-	Ω
				9	ı	0.5	-	-	-	-	-	Ω
Quiescent Device	Icc	V _{CC} or	-	6	i	-	2	-	20	-	40	μΑ
Current		GND	GND	10	1	-	16	-	160	-	320	μА
HCT TYPES												
High Level Input Voltage	V _{IH}	-	-	4.5 to 5.5	2	-	-	2	-	2	-	V
Low Level Input Voltage	V _{IL}	-	-	4.5 to 5.5	-	-	0.8	-	0.8	-	0.8	V
Input Leakage Current (Any Control)	Ι _{ΙL}	V _{CC} or GND	-	5.5	-	-	±0.1	-	±1	-	±1	μА
Off-Switch Leakage Current	IZ	V _{IL}	V _{CC} or GND	5.5	-	-	±0.1	-	±1	-	±1	μА
"ON" Resistance I _O = 1mA	R _{ON}	V _{CC}	V _{CC} or GND	4.5	-	25	80	-	106	-	128	Ω
(Figure 1)			V _{CC} to GND	4.5	-	35	95	-	118	-	142	Ω
"ON" Resistance Between Any Two Switches	ΔR _{ON}	V _{CC}	-	4.5	-	1	-	-	-	-	-	Ω
Quiescent Device Current	I _{CC}	V _{CC} or GND	-	5.5	-	-	2	-	20	-	40	μА
Additional Quiescent Device Current Per Input Pin: 1 Unit Load	ΔI _{CC} (Note 3)	V _{CC} - 2.1	-	4.5 to 5.5	-	100	360	-	450	-	490	μА

NOTE:

HCT Input Loading Table

INPUT	UNIT LOADS
All	1

NOTE: Unit Load is ΔI_{CC} limit specified in DC Electrical Specifications table, e.g., $360\mu A$ max at $25^{\circ}C$.

^{3.} For dual-supply systems theoretical worst case ($V_I = 2.4V$, $V_{CC} = 5.5V$) specification is 1.8mA.

Switching Specifications Input t_r , t_f = 6ns

		TEST	v _{cc}		25°C		-40°C 1	O 85°C	-55°C TO 125°C		
PARAMETER	SYMBOL	CONDITIONS	(V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
HC TYPES				•	•			•	•	•	
Propagation Delay Time	t _{PLH} , t _{PHL}	C _L = 50pF	2	-	-	60	-	75	-	90	ns
Switch In to Out			4.5	-	-	12	-	15	-	18	ns
			9	-	-	8	-	11	-	13	ns
		C _L = 15pF	5	-	4	-	-	-	-	-	ns
Propagation Delay Time	t _{PZH} , t _{PZL}	C _L = 50pF	2	-	-	100	-	125	-	150	ns
Switch Turn On Delay			4.5	-	-	20	-	25	-	30	ns
			9	-	-	12	-	15	-	18	ns
	C _L = 15pF	5	-	8	-	-	-	-	-	ns	
Propagation Delay Time	t _{PHZ} , t _{PLZ}	C _L = 50pF	2	-	-	150	-	190	-	225	ns
Switch Turn Off Delay			4.5	-	-	30	-	38	-	45	ns
			9	-	-	24	-	30	-	36	ns
		C _L = 15pF	5	-	12	-	-	-	-	-	ns
Input (Control) Capacitance	Cl	-	-	-	-	10	-	10	-	10	pF
Power Dissipation Capacitance (Notes 4, 5)	C _{PD}	-	5	-	25	-	-	-	-	-	pF
HCT TYPES	•			•	•						
Propagation Delay Time	t _{PLH} , t _{PHL}	C _L = 50pF	4.5	-	-	12	-	15	-	18	ns
Switch In to Out		C _L = 15pF	5	-	4	-	-	-	-	-	ns
Propagation Delay Time	t _{PZH} , t _{PZL}	C _L = 50pF	4.5	-	-	24	-	30	-	36	ns
Switch Turn On Delay		C _L = 15pF	5	-	9	-	-	-	-	-	ns
Propagation Delay Time	t _{PHZ} , t _{PLZ}	C _L = 50pF	4.5	-	-	35	-	44	-	53	ns
Switch Turn Off Delay		C _L = 15pF	5	-	14	-	-	-	-	-	ns
Input (Control) Capacitance	Cl	-	-	-	-	10	-	10	-	10	pF
Power Dissipation Capacitance (Notes 4, 5)	C _{PD}	-	5	-	38	-	-	-	-	-	pF

NOTES:

- 4. C_{PD} is used to determine the dynamic power consumption, per package.
 5. P_D = C_{PD} V_{CC}² f_i + Σ (C_L + C_S) V_{CC}² f_o where f_i = input frequency, f_o = output frequency, C_L = output load capacitance, C_S = switch capacitance, V_{CC} = supply voltage.

Analog Channel Specifications $T_A = 25^{\circ}C$

PARAMETER	TEST CONDITIONS	V _{CC} (V)	HC4066	CD74HCT4066	UNITS
Switch Frequency Response Bandwidth at -3dB Figure 2	Figure 5, Notes 6, 7	4.5	200	200	MHz
Cross Talk Between Any Two Switches Figure 3	Figure 4, Notes 7, 8	4.5	-72	-72	dB
Total Harmonic Distortion	Figure 6, 1kHz, V _{IS} = 4V _{P-P}	4.5	0.022	0.023	%
	Figure 6, 1kHz, V _{IS} = 8V _{P-P}	9	0.008	N/A	%

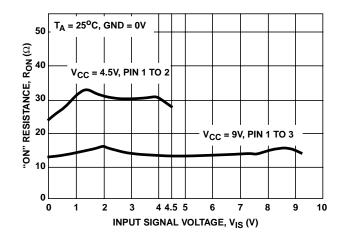
Analog Channel Specifications $T_A = 25^{\circ}C$ (Continued)

PARAMETER	TEST CONDITIONS	V _{CC} (V)	HC4066	CD74HCT4066	UNITS
Control to Switch Feedthrough Noise	Figure 7	4.5	200	130	mV
		9	550	N/A	mV
Switch "OFF" Signal Feedthrough Figure 3	Figure 8, Notes 7, 8	4.5	-72	-72	dB
Switch Input Capacitance, C _S		-	5	5	pF

NOTES:

- 6. Adjust input level for 0dBm at output, f = 1MHz.
- 7. V_{IS} is centered at $V_{CC}/2$.
- 8. Adjust input for 0dBm at V_{IS}.

Typical Performance Curves



C_L = 10pF V_{CC} = 4.5V R_L = 50Ω T_A = 25°C PIN 4 TO 3 FREQUENCY, f (Hz)

FIGURE 1. TYPICAL "ON" RESISTANCE vs INPUT SIGNAL VOLTAGE

FIGURE 2. SWITCH FREQUENCY RESPONSE, $V_{CC} = 4.5V$

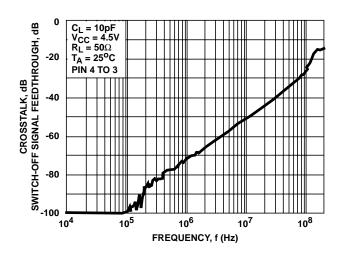
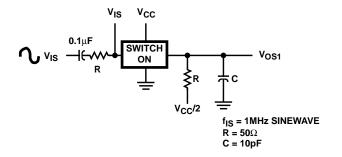


FIGURE 3. SWITCH-OFF SIGNAL FEEDTHROUGH AND CROSSTALK vs FREQUENCY, $V_{CC} = 4.5V$

Analog Test Circuits



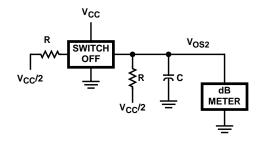
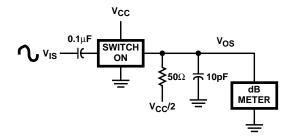


FIGURE 4. CROSSTALK BETWEEN TWO SWITCHES TEST CIRCUIT



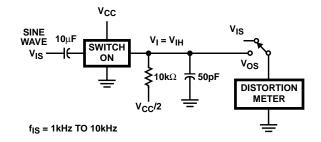
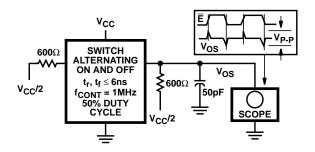


FIGURE 5. FREQUENCY RESPONSE TEST CIRCUIT

FIGURE 6. TOTAL HARMONIC DISTORTION TEST CIRCUIT



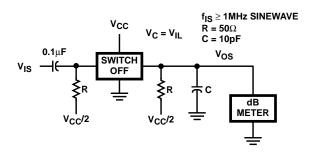
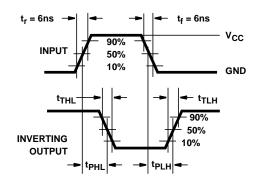


FIGURE 7. CONTROL-TO-SWITCH FEEDTHROUGH NOISE TEST CIRCUIT

FIGURE 8. SWITCH OFF SIGNAL FEEDTHROUGH

Test Circuits and Waveforms



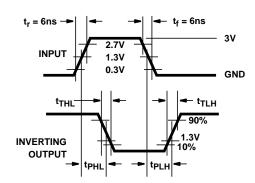


FIGURE 9. HC TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

FIGURE 10. HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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